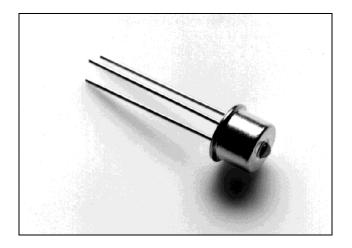


RCLED 650 nm, Plastic Optical Fiber Communications - 125 to 250 Mbps

Data Sheet

June 2004



Features

- · Optimized wavelength for Plastic optical fiber
- · High Bandwidth
- · No threshold
- · Surface emitting
- · High coupling efficiency
- · Hermetically sealed

Applications

- Fast Ethernet
- IEEE1394b
- 155 Mbps ATM
- · Home networking
- · Industrial applications

Ordering Information ZL60003/TBD TO-46 Package -20°C to +70°C

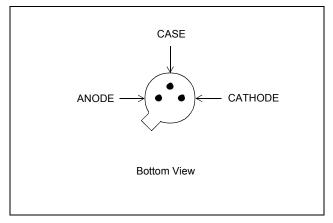


Figure 1 - Pin Description

Description

This unique Resonant Cavity Surface-Emitting LED (RCLED) is designed for optical communications over Plastic Optical Fiber (POF) in applications such as Fast Ethernet, IEEE1394b (S100, S200) and 155 Mbps ATM. Optimised high-speed performance can be achieved by use of a suitable electrical preemphasis within the drive circuitry.

ZL60003 is also well suited for applications where visible light is required, such as in sensing and positioning.

ZL60003 Data Sheet

Optical and Electronic characteristics (25°C Case temperature)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Fiber-Coupled Power	P _{fiber}	1.2			mW	/ _F = 30 mA (Note1)	
Optical Power	Po		2.0		mW	/ _F = 30 mA	
Beam Divergence (FWHM)	2Θ _{1/2}		25		deg	/ _F = 30 mA	
Rise and Fall Time	t_{R} , t_{F}			3.5	ns	I _F = 30 mA (Note1,2)	
Peak Wavelength	λр	640	650	660	nm	/ _F = 30 mA (Note1)	
Spectral Width (FWHM)	Δλ			20	nm	I _F = 30 mA (Note1)	
Forward Voltage	V _F			2.3	V	/ _F = 30 mA	

Note 1: Fiber: POF 980/1000 μ m Step Index, NA=0.48. For high speed communication, a low NA POF or a graded index POF are recommended.

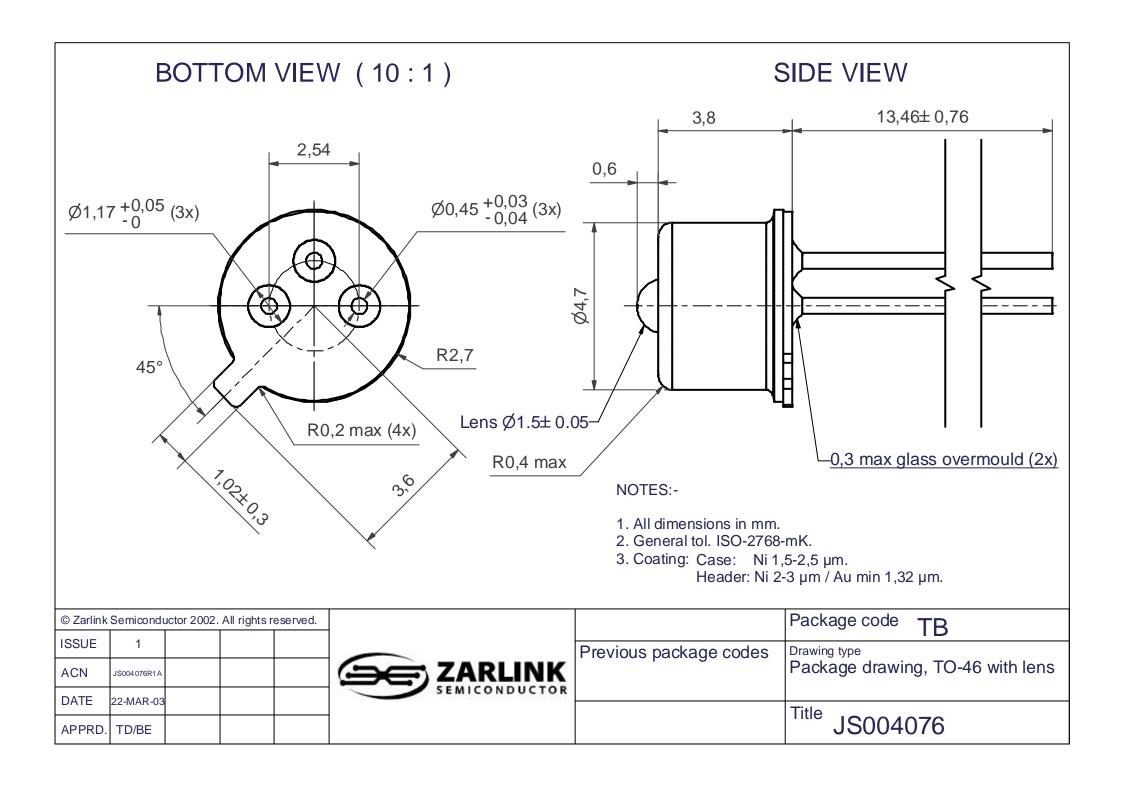
Absolute Maximum Ratings

Parameter	Symbol	Limit	
Storage Temperature	T _{stg}	-55 to +125°C	
Operating Temperature	T_{op}	-20 to +70°C	
Electrical Power Dissipation	P _{tot}	130 mW	
Continuous Forward Current (f<10 kHz)	I _F	40 mA	
Peak Forward Current (duty cycle<50%,f>1 MHz	/ _{FRM}	85 mA	
Reverse Voltage	V_{R}	5 V	
Soldering Temperature (2 mm from the case for 10 sec.)	T_{sld}	260°C	

Thermal Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance - Infinite Heat Sink	R _{thjc}		200		°C/W
Thermal Resistance - No Heat Sink	R _{thja}		500		°C/W
Temp. Coefficient - Wavelength	$\mathrm{d}\lambda/\mathrm{d}T_\mathrm{j}$		0.08		nm/°C
Optical Power - Fiber Coupled	$\mathrm{d}P_\mathrm{f}/\mathrm{d}T_\mathrm{j}$		-0.7		%/°C

Note 2: Unfiltered 20%-80% measurement. Note significant improvements can be achieved by use of pre-emphasis in the drive circuitry.





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